

## DF005S thru DF10S

# SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIERS

REVERSE VOLTAGE - 50 to 1000 Volts FORWARD CURRENT - 1.0 Amperes

#### **FEATURES**

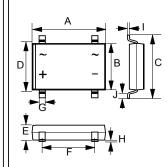
- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop high current capability.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0
- UL recognized file # E95060
- ESD Capability: Machine Model, C (> 400 V)
   Human Body Model, 3A (4 to <8 kV)</li>

#### **MECHANICAL DATA**

Polarity :As marked on BodyWeight : 0.02 ounces, 0.38 grams

• Mounting position : Any

#### DF-S



DF-S							
DIM.	MIN.	MAX.					
Α	8.20	8.50					
В	6.20	6.50					
С	-	10.30					
D	7.40	7.90					
E	2.40	2.60					
F	5.00	5.20					
G	1.00	_					
Н	.076	.330					
I	0.22	0.30					
J	1.02	1.53					
All Dimensions in millimeter							

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

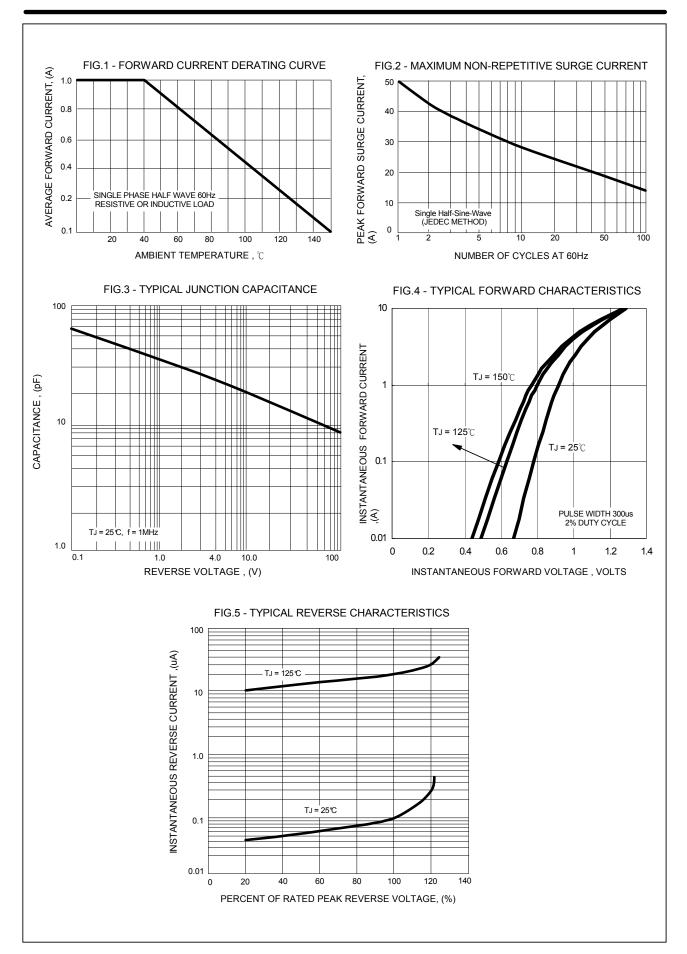
CHARACTERISTICS	SYMBOL	DF005S	DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @TA=40°C	I(AV)	1.0							Α
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	IFSM	IFSM 50							А
Maximum forward Voltage at 1.0A DC	VF	1.1							V
Maximum DC Reverse Current @TJ =25°C at Rated DC Blocking Voltage @TJ =125°C	lR	10 500						uA	
I <sup>2</sup> t Rating for fusing (t < 8.3ms)	l² t	10.4							A <sup>2</sup> S
Typical Junction Capacitance per element (Note 1)	Cì	25						pF	
Typical Thermal Resistance (Note 2)	Reja Rejc Rejl	40 8 20					°C/W		
Operating Temperature Range	TJ	-55 to +150					°C		
Storage Temperature Range	Тѕтс			-	55 to +150	)			°C

NOTES: 1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

2.Thermal resistance from junction to ambient mounted on P.C.B with 0.5x0.5"(13x13mm) copper pads.

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